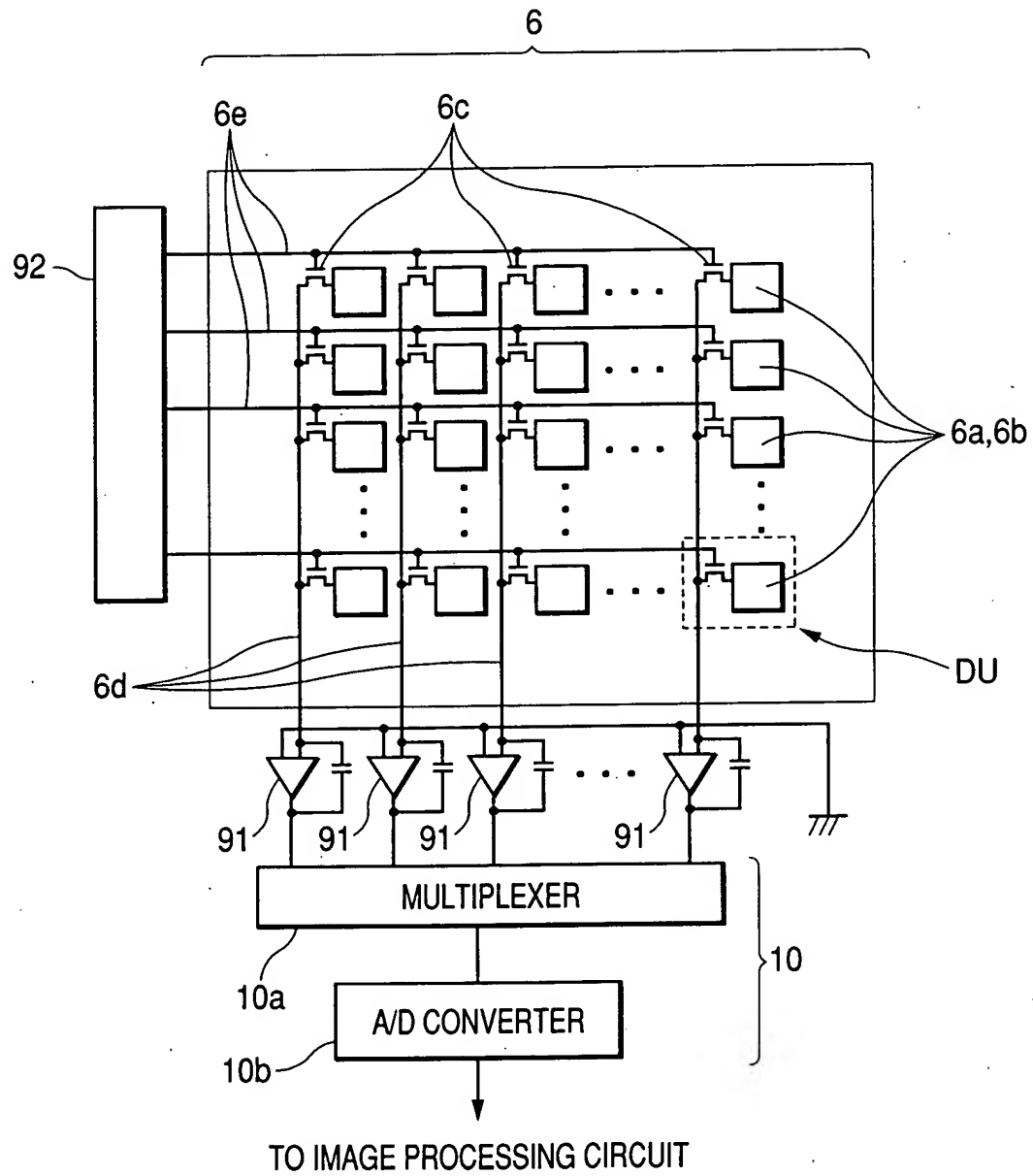
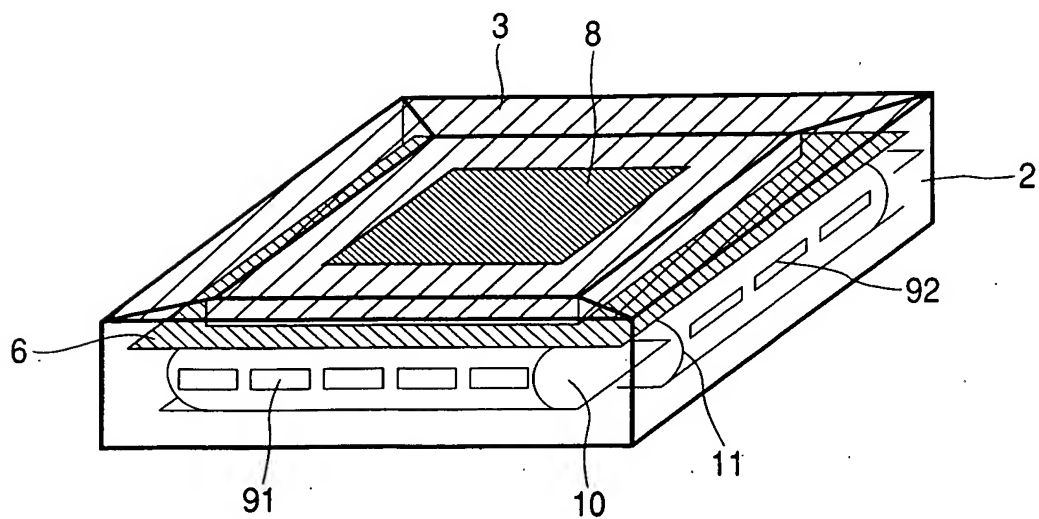


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FIG. 2





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FIG. 5

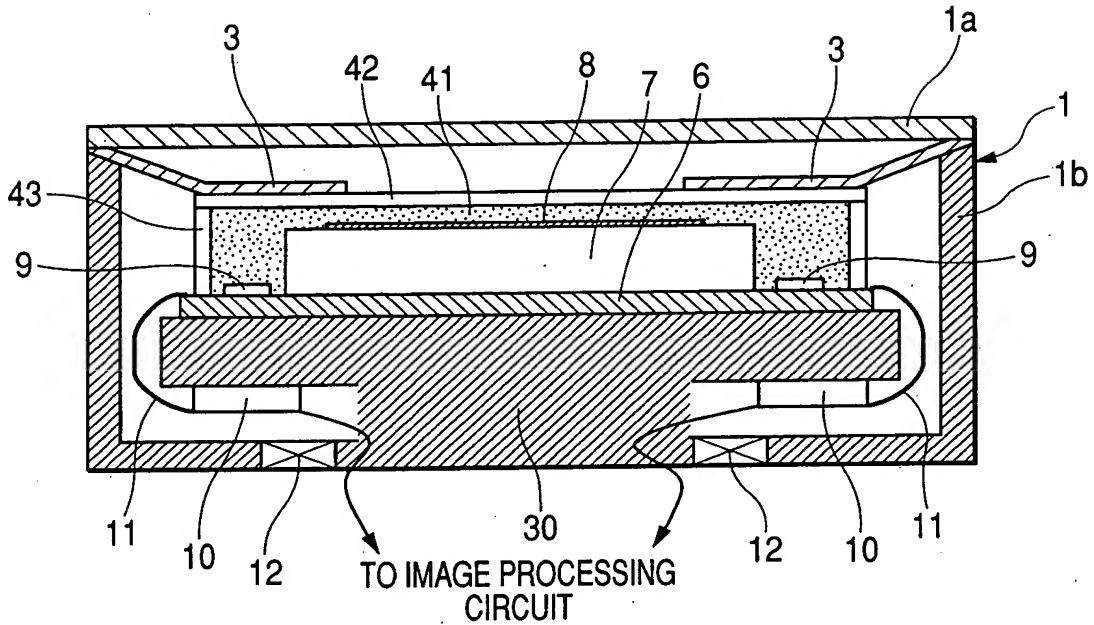
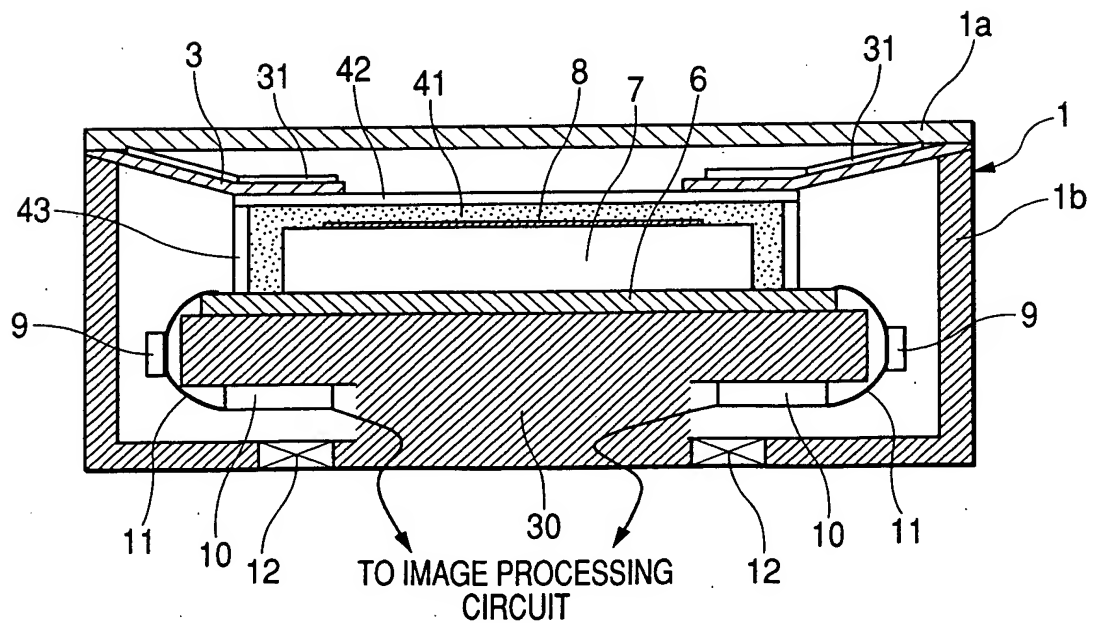


FIG. 6



[illegible]

A cross-sectional view of a solid-state image pickup device. The device is housed within a rectangular frame 101. A central horizontal component 6 is shown, with a layer 7 on top and a layer 8 below it. The central component is flanked by two vertical structures 9. Below the central component, there are two sets of horizontal structures 10 and 11, which are connected to a common line 12. Arrows point from these structures to the text "TO IMAGE PROCESSING CIRCUIT". A central vertical line 30 is also shown.